



N-Channel Enhancement-Mode Vertical DMOS FET

Features

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C_{ISS} and fast switching speeds
- Excellent thermal stability
- Integral source-drain diode
- ► High input impedance and high gain
- ▶ Hi-Rel processing available

Applications

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

General Description

The Supertex 2N6661 is an enhancement-mode (normally-off) transistor that utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors, and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

Device	Package Option	BV _{DSS} /BV _{DGS}	$R_{DS(ON)} \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	I _{D(ON)} (min) (A)
2N6661	TO-39	90	4.0	1.5

Package is RoHS compliant ('Green')





Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	BV _{DSS}
Drain-to-gate voltage	BV_{DGS}
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C
Soldering temperature*	+300°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Pin Configuration



(Case : Drain)

Product Marking



Package may or may not include the following marks: Si or 🎧

TO-39

^{*} Distance of 1.6mm from case for 10 seconds.

Thermal Characteristics

Package	l _D (continuous) [†] (mA)	I _D (pulsed) (A)	Power Dissipation @T _c = 25°C (W)	θ _{jc} (°C/W)	θ _{ja} (°C/W)	_{DR}	I _{DRM} (A)
TO-39	350	3.0	6.25	20	125	350	3.0

 $[\]uparrow I_D$ (continuous) is limited by max rated T_D

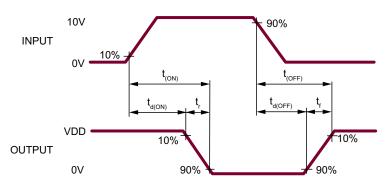
Electrical Characteristics (*T_A* = 25°C unless otherwise specified)

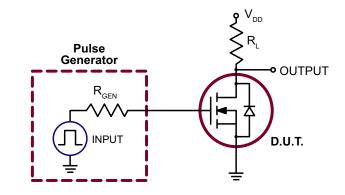
Sym	Parameter	Min	Тур	Max	Units	Conditions	
BV _{DSS}	Drain-to-source breakdown voltage	90	-	-	V	$V_{GS} = 0V, I_{D} = 10\mu A$	
V _{GS(th)}	Gate threshold voltage	8.0	-	2.0	V	$V_{GS} = V_{DS}$, $I_{D} = 1.0$ mA	
$\Delta V_{GS(th)}$	V _{GS(th)} change with temperature	-	-3.8	-5.5	mV/°C	$V_{GS} = V_{DS}$, $I_{D} = 1.0$ mA	
I _{GSS}	Gate body leakage current	-	-	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
		-	-	10		$V_{GS} = 0V$, $V_{DS} = Max rating$	
I _{DSS}	Zero gate voltage drain current	-	-	500	μA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$, $T_A = 125^{\circ}C$	
I _{D(ON)}	On-state drain current	1.5	-	-	Α	$V_{GS} = 10V, V_{DS} = 10V$	
В	Static drain-to-source	-	-	5.0	Ω	$V_{GS} = 5.0V, I_{D} = 0.3A$	
R _{DS(ON)}	on-state resistance	-	-	4.0	12	$V_{GS} = 10V, I_{D} = 1.0A$	
G_{FS}	Forward transconductance	170	-	-	mmho	$V_{DS} = 25V, I_{D} = 0.5A$	
C _{ISS}	Input capacitance	-	-	50		V _{GS} = 0V,	
C _{oss}	Common source output capacitance	-	-	40	pF	V _{DS} = 24V, f = 1.0MHz	
C _{RSS}	Reverse transfer capacitance	-	-	10			
t _(ON)	Turn-on time	-	-	10	ne	$V_{DD} = 25V, I_{D} = 1.0A,$ $R_{GEN} = 25\Omega$	
t _(OFF)	Turn-off time	-	-	10	ns		
V _{SD}	Diode forward voltage drop	-	1.2	-	V	V _{GS} = 0V, I _{SD} = 1.0A	
t _{rr}	Reverse recovery time	-	350	_	ns	V _{GS} = 0V, I _{SD} = 1.0A	

Notes:

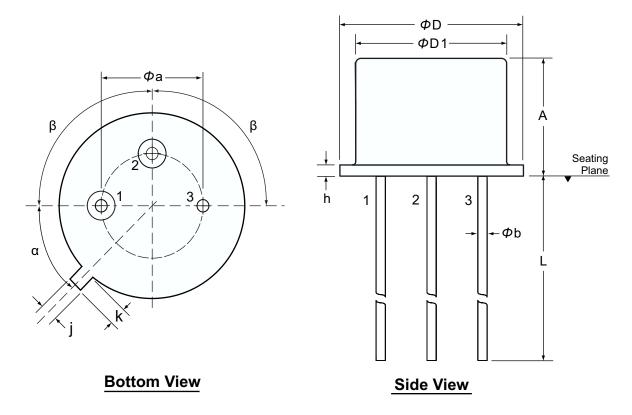
- 1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

Switching Waveforms and Test Circuit





3-Lead TO-39 Package Outline (N2)



Symbo	ol	α	β	Α	Фа	Φb	ΦD	Φ D1	h	j	k	L
Dimension (inches)	MIN			.240	.190	.016	.350	.315	.009	.028	.029	.500
	NOM	45° NOM		-	-	-	-	-	-	-	-	-
	MAX			.260	.210	.021	.370	.335	.125	.034	.040	.560*

JEDEC Registration TO-39.

Drawings not to scale.

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(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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^{*} This dimension is not specified in the JEDEC drawing.

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Microchip: 2N6661